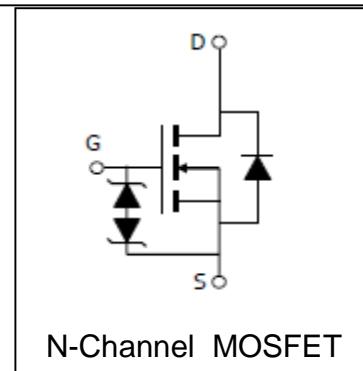
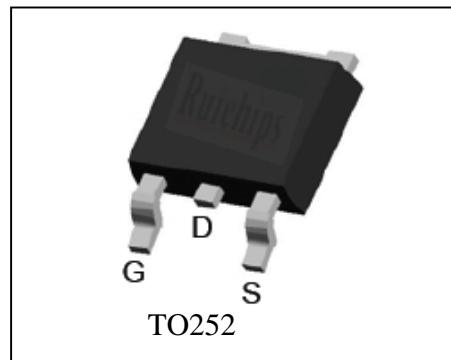


**Features**

- 60V/16A,  
 $R_{DS(ON)} = 60\text{m}\Omega$  (tpy.) @  $V_{GS} = 10\text{V}$   
 $R_{DS(ON)} = 75\text{m}\Omega$  (tpy.) @  $V_{GS} = 4.5\text{V}$
- Super High Dense Cell Design
- ESD protected
- Reliable and Rugged
- 100% avalanche tested
- Lead Free and Green Devices Available  
(RoHS Compliant)

**Applications**

- Power Management

**Pin Description****Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit
<b>Common Ratings</b> ( $T_c = 25^\circ\text{C}$ Unless Otherwise Noted)			
$V_{DSS}$	Drain-Source Voltage	60	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	175	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
$I_S$	Diode Continuous Forward Current	$T_c = 25^\circ\text{C}$	A
<b>Mounted on Large Heat Sink</b>			
$I_{DP}$	300 $\mu\text{s}$ Pulse Drain Current Tested	$T_c = 25^\circ\text{C}$	64 <sup>①</sup>
$I_D$	Continuous Drain Current	$T_c = 25^\circ\text{C}$	16 <sup>②</sup>
		$T_c = 100^\circ\text{C}$	11.5
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ\text{C}$	40
		$T_c = 100^\circ\text{C}$	20
$R_{\theta JC}$	Thermal Resistance-Junction to Case	3.75	$^\circ\text{C}/\text{W}$
<b>Drain-Source Avalanche Ratings</b>			
$E_{AS}^{③}$	Avalanche Energy, Single Pulsed	25	mJ

## Electrical Characteristics ( $T_C=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	RU60E16L			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=250\mu\text{A}$	60			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}= 60\text{V}, V_{\text{GS}}=0\text{V}$			1	$\mu\text{A}$
		$T_J=85^\circ\text{C}$			30	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=250\mu\text{A}$	1.5	2	2.7	V
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm 16\text{V}, V_{\text{DS}}=0\text{V}$			$\pm 10$	$\mu\text{A}$
$R_{\text{DS(ON)}}^{(4)}$	Drain-Source On-state Resistance	$V_{\text{GS}}= 10\text{V}, I_{\text{DS}}=8\text{A}$		60	75	$\text{m}\Omega$
		$V_{\text{GS}}= 4.5\text{V}, I_{\text{DS}}=5.5\text{A}$		75	90	$\text{m}\Omega$
<b>Diode Characteristics</b>						
$V_{\text{SD}}^{(4)}$	Diode Forward Voltage	$I_{\text{SD}}=8\text{A}, V_{\text{GS}}=0\text{V}$			1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_{\text{SD}}=8\text{A}, dI_{\text{SD}}/dt=100\text{A}/\mu\text{s}$		38		ns
$Q_{\text{rr}}$	Reverse Recovery Charge			67		nC
<b>Dynamic Characteristics</b> <sup>(5)</sup>						
$R_{\text{G}}$	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$		1.3		$\Omega$
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V},$		480		$\text{pF}$
$C_{\text{oss}}$	Output Capacitance	$V_{\text{DS}}= 30\text{V},$		75		
$C_{\text{rss}}$	Reverse Transfer Capacitance	Frequency=1.0MHz		48		
$t_{\text{d(ON)}}$	Turn-on Delay Time			15		ns
$t_{\text{r}}$	Turn-on Rise Time	$V_{\text{DD}}=30\text{V}, R_{\text{L}}=3.8\Omega,$		18		
$t_{\text{d(OFF)}}$	Turn-off Delay Time	$I_{\text{DS}}=8\text{A}, V_{\text{GEN}}= 10\text{V},$		33		
$t_{\text{f}}$	Turn-off Fall Time	$R_{\text{G}}=4.7\Omega$		16		
<b>Gate Charge Characteristics</b> <sup>(5)</sup>						
$Q_{\text{g}}$	Total Gate Charge	$V_{\text{DS}}=48\text{V}, V_{\text{GS}}= 10\text{V},$		14	18	nC
$Q_{\text{gs}}$	Gate-Source Charge			2.9		
$Q_{\text{gd}}$	Gate-Drain Charge			5.2		

Notes:

- ①Pulse width limited by safe operating area.

- ②Calculated continuous current based on maximum allowable junction temperature.

- ③Limited by  $T_{J\text{max}}, I_{\text{AS}} = 10\text{A}, V_{\text{DD}} = 48\text{V}, R_{\text{G}} = 50\Omega$ , Starting  $T_J = 25^\circ\text{C}$ .

- ④Pulse test ; Pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ .

- ⑤Guaranteed by design, not subject to production testing.

## Typical Characteristics

